GEM R&D from the Chinese Groups

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The Study of GEM Foils at CIAE

- 1. Kapton foil covered with copper has got from the manufacturer in China;
- Photoresist coating and masking Cooperated with the factory, can make 50µm diameter and 5cm×5cm total area mask plate;
- 3. Copper etching have some problems, they could be solved after getting the technology transfer from CERN;
- 4. Kapton etching: CIAE has over 20 years experience of nuclear pore foil production and kapton etching;
- 5. Clean room is ready for the study of GEM foils.







PCB Factory, THGEM Foil Production and Test (Collaborated with IHEP)

Laminator



Photo etching machine



Etching Machine



The PCB factory is located in the south of Beijing. They would like to make the GEM foils for us if we provide the technology support.

	GEM	THGEM
Manufacturer	CERN PCB Factory	Most PCB Factories
Cleanliness Level	Very High	Normal
Easy to Damage	Yes	No
Cost	High	Low
Detection Efficiency	High	Low
Spatial Resolution	~70µm	~300µm



0.2mm Diameter THGEM Foil

THGEM Prototype





The Analysis of GEM Test at JLab 2011



- 1. No spatial resolution test.
- 2. Couldn't adjust operating parameters to explore better performance.
- 3. At present no available hardware, hoping to do some simulation work to seek optimum design parameters.





The Simulation of GEM Chamber Electric Field





Near Future work Plan

- 1. A new way to make GEM foil has been discussed, and is going to be tried. If it works, then the procedure of GEM foil production will be simplified.
- 2. Test spatial resolutions for GEM and THGEM.
- 3. Design read-out electrode.
- 4. Input electric field data to Geant4 package, and compare Geant4 results to the data from the GEM test at JLab. Use simulation results to study spatial resolution, explore better operating parameters, and improve imminent experimental setup at CIAE.



Micromegas R&D Activity in Lanzhou University

Micromegas detector has been developed

The imaging test has been done in the Am+Be neutron source



Micromegas Development in Lanzhou University





Readout Anode and FEE





Micromegas Neutron (Am+Be source) Imaging Results



CEA

Slits



Near Future Work Plan

DAQ system setup based on the Micromegas and "AFTER" chip (Up to 2000 Channels)

Build the large area GEM detector and a test platform

Update the FEE, replace the "AFTER" by APV25-S1



GEM R&D Activities at Tsinghua

GEM-based TPC readout (by Yulan LI) 16 channel CSA and shaping amplifier (by Zhi Deng) Planar GEM tracking detector prototype test (by Zhigang Xiao)









GEM Prototypes with two Readout Design



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Test Results 1 : Effective Gas Gain



Working Gas: CO₂+Ar



Gain factor stably increase
with HV at all gas mixture



Test Results 2 : Energy Resolution



Wire fired in one hit



Near Future work Plan







Work on Micromegas R&D







Work on MRPC (STAR Collaboration)

Mass Production in USTC



PID of TOFr tray





dE/dx after TOFr PID cut



Beam Test Results

	Efficiency	Time Resolution
5-gap MRPC	>90%	70ps
6-gap MRPC	>97%	60ps
2 × 5-gap MRPC	>99%	50ps







Work on Small Area (10cm×10cm) GEM R&D







Position Resolution : $\sigma \sim 150 \mu m$



Activity for Large Area GEM





Mar.-29-2011: State key Laboratory of Particle Detection and Electronics



Charge sensitive pre-amplifiers and flash ADCs are got, which can be used for the test of the basic detector performance (gain , efficiency, uniformity, etc) before we get the APV25 based electronics







Near Future Work Plan

- ➢Build a large GEM (40x50 cm²) detector;
- Set up the test stand (gas flow system, cosmic ray test platform, DAQ ...)
- >Set up the electronics read out system with multichannels (200 \sim 1000 channels)
- Build up models with different area (trapeziform GEM) needed for SOLID

≻Beam test

